

80SQ045N

Preferred Device

Axial Lead Rectifier

These devices employ the Schottky Barrier principle in a large area metal-to-silicon power diode. State-of-the-art geometry features epitaxial construction with oxide passivation and metal overlap contact. Ideally suited for use as rectifiers in low-voltage, high-frequency inverters, free wheeling diodes, and polarity protection diodes.

Features

- High Current Capability
- Low Stored Charge, Majority Carrier Conduction
- Low Power Loss/High Efficiency
- Highly Stable Oxide Passivated Junction
- Guard-Ring for Stress Protection
- Low Forward Voltage
- High Surge Capacity
- These are Pb-Free Devices*

Mechanical Characteristics:

- Case: Epoxy, Molded
- Weight: 1.1 Gram (Approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 220°C Max. for 10 Seconds, 1/16" from Case
- Polarity: Cathode indicated by Polarity Band
- ESD Protection: Human Body Model > 4000 V (Class 3)
Machine Model > 400 V (Class C)

MAXIMUM RATINGS

| Rating | Symbol | Max | Unit |
|---|---------------------------------|-------------|------------------|
| Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage | V_{RRM} V_{RWM} V_R | 45 | V |
| Average Rectified Forward Current $T_L = 75^\circ\text{C}$ ($\text{Psi}_{JL} = 12^\circ\text{C/W}$, P.C. Board Mounting, Note 2) | I_O | 8.0 | A |
| Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz) | I_{FSM} | 140 | A |
| Operating and Storage Junction Temperature Range (Reverse Voltage Applied) | T_J, T_{stg} | -65 to +125 | $^\circ\text{C}$ |
| Voltage Rate of Change (Rated V_R) | dv/dt | 10 | V/ns |

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

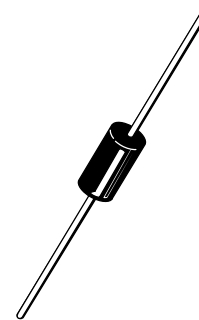
*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.



ON Semiconductor®

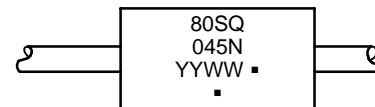
<http://onsemi.com>

SCHOTTKY BARRIER RECTIFIER 8.0 AMPERES



AXIAL LEAD
CASE 267-05
(DO-201AD)
STYLE 1

MARKING DIAGRAM



YY = Year
WW = Work Week
▪ = Pb-Free Package

(Note: Microdot may be in either location)

ORDERING INFORMATION

| Device | Package | Shipping† |
|-------------|-------------|------------------|
| 80SQ045N | Axial Lead* | 500 Units/Box |
| 80SQ045NG | Axial Lead* | 500 Units/Box |
| 80SQ045NRL | Axial Lead* | 1500/Tape & Reel |
| 80SQ045NRLG | Axial Lead* | 1500/Tape & Reel |

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

*This package is inherently Pb-Free.

Preferred devices are recommended choices for future use and best overall value.

80SQ045N

THERMAL CHARACTERISTICS

| Characteristic | Symbol | 0.9 in x 0.9 in Copper Pad Size | 6.75 in x 6.75 in Copper Pad Size | Unit |
|--|-----------------|---------------------------------|-----------------------------------|---------------|
| Thermal Resistance, Junction-to-Lead (See Note 2 – Mounting Data) | $R_{\theta JL}$ | 13 | 12 | $^{\circ}C/W$ |
| Thermal Resistance, Junction-to-Ambient (See Note 2 – Mounting Data) | $R_{\theta JA}$ | 50 | 40 | |

ELECTRICAL CHARACTERISTICS ($T_L = 25^{\circ}C$ unless otherwise noted)

| Characteristic | Symbol | Max | Unit |
|--|--------|-----------|------|
| Maximum Instantaneous Forward Voltage (Note 1) ($i_F = 8.0 A$, $T_L = 25^{\circ}C$) | V_F | 0.55 | V |
| Maximum Instantaneous Reverse Current @ Rated dc Voltage (Note 1) $T_L = 25^{\circ}C$ $T_L = 100^{\circ}C$ | i_R | 1.0 50 | mA |

1. Pulse Test: Pulse Width = 300 μs , Duty Cycle = 2.0%.

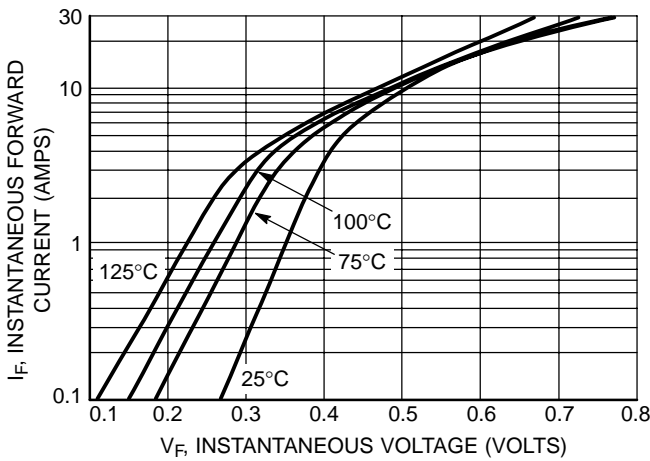


Figure 1. Typical Forward Voltage

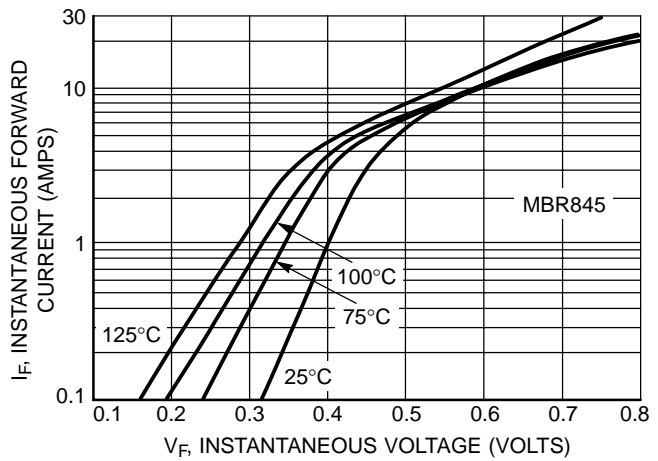


Figure 2. Maximum Forward Voltage

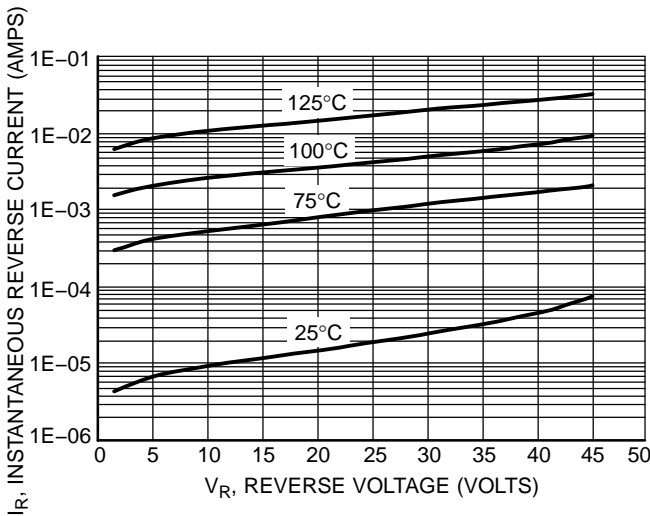


Figure 3. Typical Reverse Current

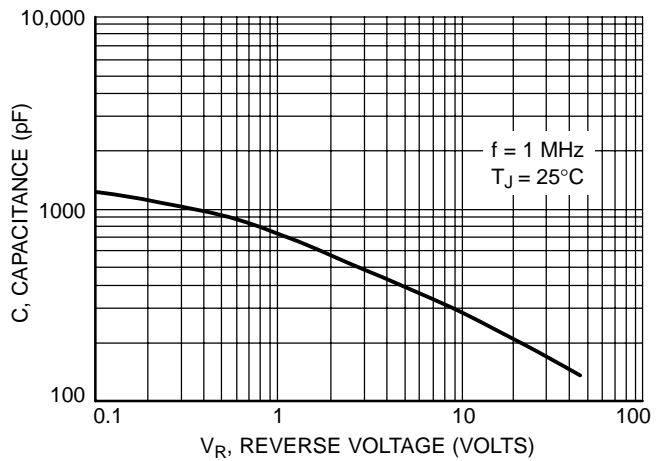


Figure 4. Typical Capacitance

80SQ045N

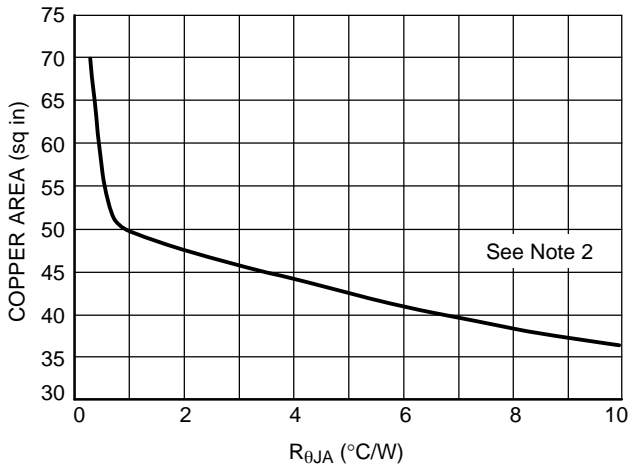


Figure 5. $R_{\theta JA}$ versus Copper Area

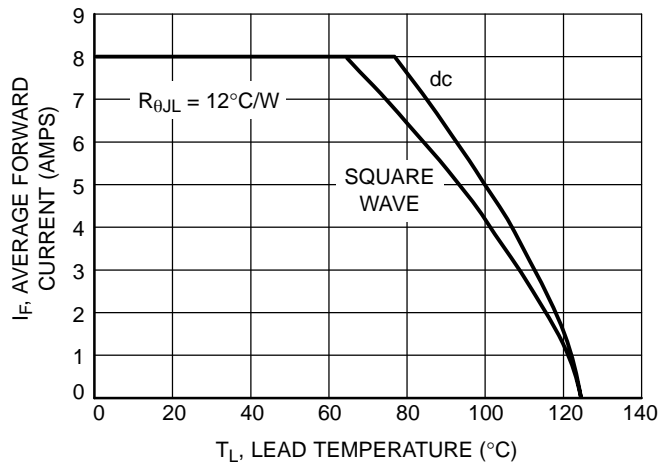


Figure 6. Current Derating - Lead

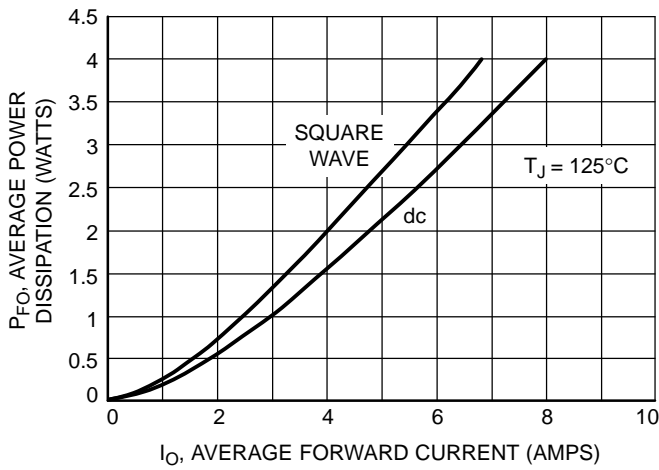


Figure 7. Forward Power Dissipation

NOTE 2 — MOUNTING DATA

Mounting Method

P.C. Board with 6.75 sq. in. copper surface.

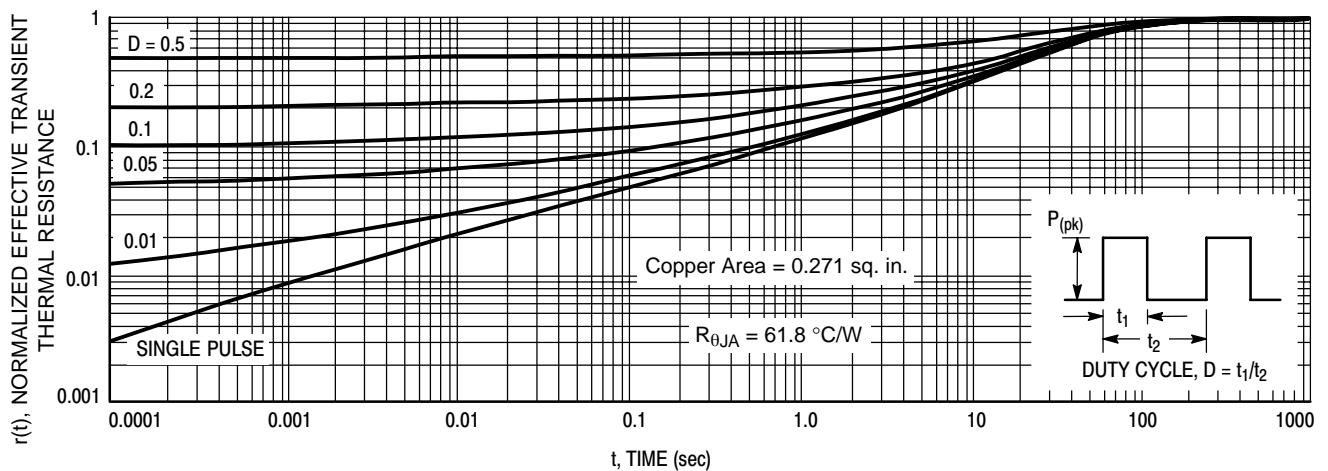
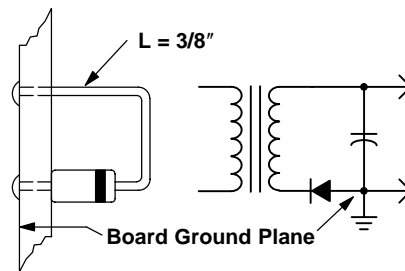
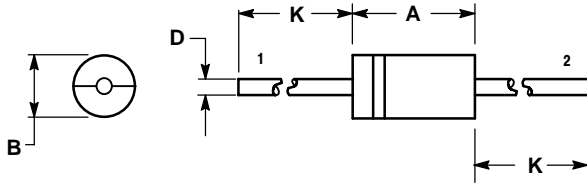


Figure 8. Thermal Response, Junction-to-Ambient

80SQ045N

PACKAGE DIMENSIONS

AXIAL LEAD CASE 267-05 ISSUE G




NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.

| DIM | INCHES | | MILLIMETERS | |
|-----|--------|-------|-------------|------|
| | MIN | MAX | MIN | MAX |
| A | 0.287 | 0.374 | 7.30 | 9.50 |
| B | 0.189 | 0.209 | 4.80 | 5.30 |
| D | 0.047 | 0.051 | 1.20 | 1.30 |
| K | 1.000 | --- | 25.40 | --- |

STYLE 1:

- PIN 1. CATHODE (POLARITY BAND)
- PIN 2. ANODE

ON Semiconductor and  are registered trademarks of Semiconductor Components Industries, LLC (SCILLC). SCILLC reserves the right to make changes without further notice to any products herein. SCILLC makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does SCILLC assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. "Typical" parameters which may be provided in SCILLC data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. SCILLC does not convey any license under its patent rights nor the rights of others. SCILLC products are not designed, intended, or authorized for use as components in systems intended for surgical implant into the body, or other applications intended to support or sustain life, or for any other application in which the failure of the SCILLC product could create a situation where personal injury or death may occur. Should Buyer purchase or use SCILLC products for any such unintended or unauthorized application, Buyer shall indemnify and hold SCILLC and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that SCILLC was negligent regarding the design or manufacture of the part. SCILLC is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor
P.O. Box 5163, Denver, Colorado 80217 USA
Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada
Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada
Email: orderlit@onsemi.com

N. American Technical Support: 800-282-9855 Toll Free
USA/Canada
Europe, Middle East and Africa Technical Support:
Phone: 421 33 790 2910
Japan Customer Focus Center
Phone: 81-3-5773-3850

ON Semiconductor Website: www.onsemi.com

Order Literature: <http://www.onsemi.com/orderlit>

For additional information, please contact your local
Sales Representative